



SLVS352C-DECEMBER 2001-REVISED MARCH 2006

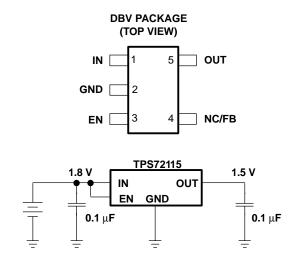
LOW INPUT VOLTAGE, CAP FREE 150-mA LOW-DROPOUT LINEAR REGULATORS

FEATURES

- 150-mA LDO
- Available in 1.5-V, 1.6-V, 1.8-V Fixed-Output and Adjustable (1.2-V to 2.5-V) Versions
- Low Input Voltage Requirement (Down to 1.8 V)
- Small Output Capacitor, 0.1-µF
- Dropout Voltage Typically 200 mV at 150 mA
- Less Than 1 µA Quiescent Current in Shutdown Mode
- Thermal Protection
- Over Current Limitation
- 5-Pin SOT-23 (DBV) Package

APPLICATIONS

- Portable Communication Devices
- Battery Powered Equipment
- PCMCIA Cards
- Personal Digital Assistants
- Modems
- Bar Code Scanners
- Backup Power Supplies
- SMPS Post Regulation
- Internet Audio



DESCRIPTION

The TPS721xx family of LDO regulators is available in fixed voltage options that are commonly used to power the latest DSPs and microcontrollers with an adjustable option ranging from 1.22 V to 2.5 V. These regulators can be used in a wide variety of applications ranging from portable, battery-powered equipment to PC peripherals. The family features operation over a wide range of input voltages (1.8 V to 5.5 V) and low dropout voltage (150 mV at full load). Therefore, compared to many other regulators that require 2.5-V or higher input voltages for operation, these regulators can be operated directly from two AAA batteries. Also, the typical guiescent current (ground pin current) is low, starting at 85 µA during normal operation and 1 µA in shutdown mode. These regulators can be operated very efficiently and. in a battery-powered application, help extend the longevity of the device.

Similar LDO regulators require 1-µF or larger output capacitors for stability. However, this regulator uses an internal compensation scheme that stabilizes the feedback loop over the full range of input voltages and load currents with output capacitances as low as 0.1-µF. Ceramic capacitors of this size are relatively inexpensive and available in small footprints.

This family of regulators is particularly suited as a portable power supply solution due to its minimal board space requirement and 1.8-V minimum input voltage. Being able to use two off-the-shelf AAA batteries makes system design easier and also reduces component cost. Moreover, the solution will be more efficient than if a regulator with a higher input voltage is used.



Please be aware that an important notice concerning availability, standard warranty, and use in critical applications of Texas Instruments semiconductor products and disclaimers thereto appears at the end of this data sheet.

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These devices have limited built-in ESD protection. The leads should be shorted together or the device placed in conductive foam during storage or handling to prevent electrostatic damage to the MOS gates.

ORDERING INFORMATION

T _J	VOLTAGE	PACKAGE	PART I	NUMBER	SYMBOL
-40°C to 125°C	Adjustable		TPS72101DBVT ⁽¹⁾	TPS72101DBVR ⁽²⁾	PEKI
	1.5 V	SOT-23	TPS72115DBVT ⁽¹⁾	TPS72115DBVR (2)	PEII
	1.6 V	(DBV)	TPS72116DBVT ⁽¹⁾	TPS72116DBVR (2)	PHFI
	1.8 V		TPS72118DBVT ⁽¹⁾	TPS72118DBVR ⁽²⁾	PEJI

¹⁾ The DBVT indicates tape and reel of 250 parts.

ABSOLUTE MAXIMUM RATINGS

over operating free-air temperature range unless otherwise noted (1)(2)

	TPS72101, TPS72115, TPS72116, TPS72118
Voltage range at IN	-0.3 V to 7 V
Voltage range at EN	-0.3 V to 7 V
Voltage on OUT, FB, NC	-0.3 V to V _I + 0.3 V
Peak output current	Internally limited
ESD rating, HBM	3 kV
Continuous total power dissipation	See Dissipation Rating Table
Operating junction temperature range, T _J	-40°C to 150°C
Storage temperature range, T _{stg}	-65°C to 150°C

⁽¹⁾ Stresses beyond those listed under absolute maximum ratings may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under recommended operating conditions is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability. All voltage values are with respect to network ground terminal.

PACKAGE DISSIPATION RATING

BOARD	PACKAGE	$R_{\Theta JC}$ $R_{\Theta JA}$		$R_{\Theta JA}$ DERATING FACTOR $T_A \le 25^{\circ}C$ POWER RATE		T _A = 70°C POWER RATING	T _A = 85°C POWER RATING	
Low-K ⁽¹⁾	DBV	65.8 °C/W	259 °C/W	3.9 mW/°C	386 mW	212 mW	154 mW	
High-K ⁽²⁾	DBV	65.8 °C/W	180 °C/W	5.6 mW/°C	555 mW	305 mW	222 mW	

⁽¹⁾ The JEDEC Low-K (1s) board design used to derive this data was a 3 inch x 3 inch, two-layer board with 2 ounce copper traces on top of the board.

⁽²⁾ The DBVR indicates tape and reel of 3000 parts.

⁽²⁾ All voltage values are with respect to network ground terminal.

⁽²⁾ The JEDEC High-K (2s2p) board design used to derive this data was a 3 inch x 3 inch, multilayer board with 1 ounce internal power and ground planes and 2 ounce copper traces on top and bottom of the board.



ELECTRICAL CHARACTERISTICS

over recommended operating junction temperature range $V_{IN} = V_{OUT(Nom)} + 1 \text{ V}, I_{OUT} = 1 \text{ mA}, EN = V_{IN}, C_{OUT} = 1 \text{ } \mu\text{F}$ (unless otherwise noted)

	PARAMETER		TEST CONDI	TIONS	MIN	TYP	MAX	UNIT		
V _{IN}	Input voltage ⁽¹⁾				1.8		5.5	V		
V_{OUT}	Output voltage range	TPS72101			1.225		2.5	V		
I _{OUT}	Continuous output curre	nt			0		150	mA		
T _J	Operating junction temp	erature			-40		125	°C		
		TPS72101	0 μA < I _{OUT} < 150 mA ⁽¹⁾	0.97 V _O		1.03 V _O				
		TD070445	$T_J = 25^{\circ}C$			1.5				
		TPS72115	0 μA < I _{OUT} < 150 mA	$2.5 \text{ V} \le \text{V}_{\text{IN}} \le 5.5 \text{ V}$	1.455		1.545			
V_{OUT}	Output voltage	TPS72116	T _J = 25°C			1.6		V		
		17572116	0 μA < I _{OUT} < 150 mA	$2.6 \text{ V} \le \text{V}_{\text{IN}} \le 5.5 \text{ V}$	1.552		1.648			
		TDC70440	T _J = 25°C			1.8				
		TPS72118	0 μA < I _{OUT} < 150 mA	$2.8 \text{ V} \le \text{V}_{\text{IN}} \le 5.5 \text{ V}$	1.746		1.854			
			T _J = 25°C			85				
	Ouisseent surrent (CND	aat)					120	Δ		
$I_{(Q)}$	Quiescent current (GND current)		I _{OUT} = 150 mA	$T_J = 25^{\circ}C$		570		μA		
			I _{OUT} = 150 mA				850			
	Standby ourrant		EN < 0.5 V	$T_J = 25^{\circ}C$		0.01		μA		
	Standby current		EN < 0.5 V			μΑ				
V_n	Output noise voltage	TPS72115	BW = 200 Hz to 100 kHz, T _J = 25°C	C _o = 1 μF		90		μV		
V_{ref}	Reference voltage		$T_J = 25$ °C			1.225		V		
PSRR	Ripple rejection		$f = 100 \text{ Hz}, C_o = 10 \mu\text{F}, I_{OUT} = 150 \text{ mA}$	T _J = 25°C; See ⁽¹⁾		48		dB		
	Current limit		See (2)		175		525	mA		
	Output voltage line regu $(\Delta V_{OUT}/V_{OUT})^{(1)}$	lation	V _O + 1 V < V _{IN} ≤ 2.5 V	T _J = 25°C		0.03	0.09	%/V		
	Output voltage load regulation	TPS72118	0 < I _{OUT} < 150 mA	T _J = 25°C		0.5		mV		
V _{IH}	EN high level input	II.			1.4					
V _{IL}	EN low level input				-0.2		0.4	V		
	ENL's and some of		EN = 0 V		-0.01		^			
I _I	EN input current		EN = IN	-0.01			μΑ			
.,	Dana and malks as (3)	TPS72118	I _{OUT} = 150 mA	T _J = 25°C	150			\/		
V_{DO}	Dropout voltage ⁽³⁾	TPS72101	I _{OUT} = 150 mA	$1.2 \text{ V} \le \text{V}_{\text{O}} \le 5.2 \text{ V}$			240	mV		
In	Feedback input current	TPS72101					1	μΑ		
	Thermal shutdown temp	erature				170		°C		
·	Thermal shutdown hyste	eresis				20		°C		

 ⁽¹⁾ Minimum IN operating voltage is 1.8 V or V_{OUT} + V_{DO}, whichever is greater.
 (2) Test condition includes output voltage V_O = 1 V and pulse duration = 10 mS.
 (3) Dropout voltage is defined as the differential voltage between V_O and V_I when V_O drops 100 mV below the value measured with V_{IN} = $V_{OUT} + V_{DO}$.



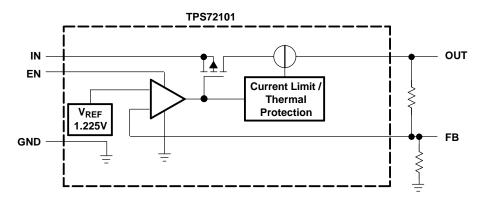
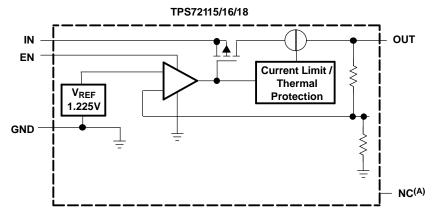


Figure 1. FUNCTIONAL BLOCK DIAGRAM—ADJUSTABLE VERSION



A. This pin must be left floating and not connected to GND.

Figure 2. FUNCTIONAL BLOCK DIAGRAM—FIXED VERSION

Terminal Functions

TERMINAL		DESCRIPTION				
NAME	NO.	DESCRIPTION				
GND	2	Ground				
EN	3	Enable input				
IN	1	Input supply voltage				
NC/FB	4	NC = Not connected (see ^(A)); FB = Feedback (adjustable option TPS72101)				
OUT	5	Regulated output voltage				

f - Frequency - Hz



IO - Output Current - mA

TYPICAL CHARACTERISTICS

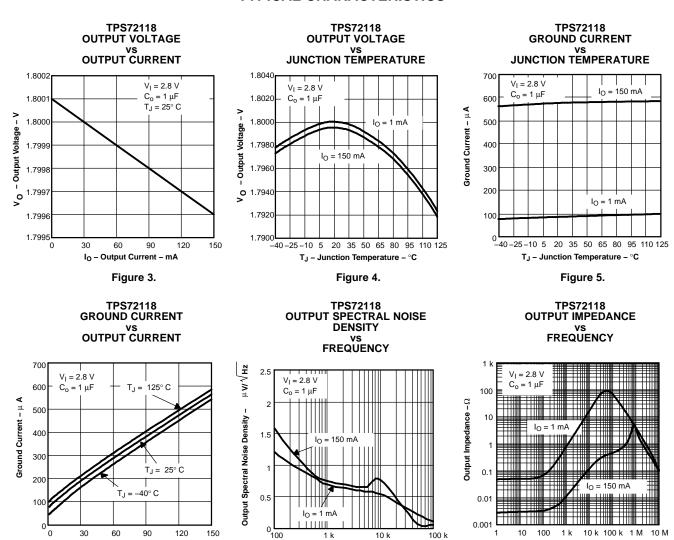


Figure 6. Figure 7. Figure 8.

f - Frequency - Hz



Figure 17.

TYPICAL CHARACTERISTICS (continued)

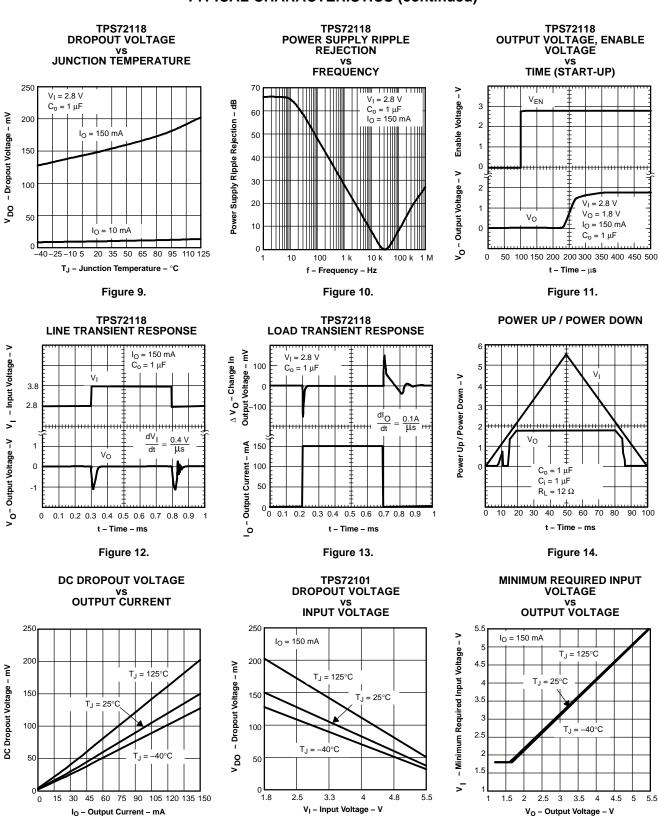


Figure 15.

Figure 16.



APPLICATION INFORMATION

The TPS721xx family of low-dropout (LDO) regulators functions with a very low input voltage (>1.8 V). The dropout voltage is typically 150 mV at full load. Typical quiescent current (ground pin current) is only 85 μ A and drops to 1 μ A in the shutdown mode.

DEVICE OPERATION

The TPS721xx family can be operated at low input voltages due to low voltage circuit design techniques and a PMOS pass element that exhibits low dropout.

A logic low on the enable input, EN, shuts off the output and reduces the supply current to less than 1 μ A. EN may be tied to V_{IN} in applications where the shutdown feature is not used.

Current limiting and thermal protection prevent damage by excessive output current and/or power dissipation. The device switches into a constant-current mode at approximately 350 mA; further load reduces the output voltage instead of increasing the output current. The thermal protection shuts the regulator off if the junction temperature rises above 170°C. Recovery is automatic when the junction temperature drops approximately 20°C below the high temperature trip point. The PMOS pass element includes a back diode that safely conducts reverse current when the input voltage level drops below the output voltage level.

A typical application circuit is shown in Figure 18.

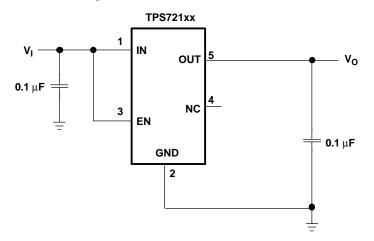


Figure 18. Typical Application Circuit

DUAL SUPPLY APPLICATION

In portable, battery-powered electronics, separate power rails for the DSP or microcontroller core voltage, $V_{(CORE)}$, and I/O peripherals (V_{IO}) are usually necessary. The TPS721xx family of LDO linear regulators is ideal for providing $V_{(CORE)}$ for the DSP or microcontroller. As shown in Figure 19, two AAA batteries provide an input voltage to a boost converter and the TPS72115 LDO linear regulator. The batteries combine input voltage ranges from 3.0 V down to 1.8 V near the end of their useful lives. Therefore, a boost converter is necessary to provide the typical 3.3 V needed for V_{IO} , and the TPS72115 linear regulator provides a regulated $V_{(CORE)}$ voltage, which in this example is 1.5 V. Although there is no explicit circuitry to perform power-up sequencing of first $V_{(CORE)}$ then V_{IO} , the output of the linear regulator reaches its regulated voltage much faster (< 400 µs) than the output of any switching type boost converter due to the inherent slow start up of those types of converters. Assuming a boost converter with minimum V_{I} of 1.8 V is appropriately chosen, this power supply solution can be used over the entire life of the two off-the-shelf AAA batteries. Thus, this solution is very efficient and the design time and overall cost of the solution is minimized.



APPLICATION INFORMATION (continued)

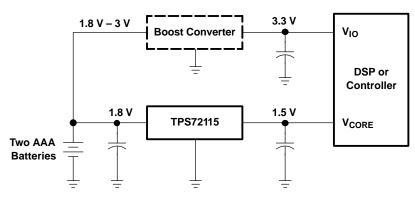


Figure 19. Dual Supply Application Circuit

EXTERNAL CAPACITOR REQUIREMENTS

A 0.1-µF ceramic bypass capacitor is required on both the input and output for stability. Larger capacitors improve transient response, noise rejection, and ripple rejection. A higher value electrolytic input capacitor may be necessary if large, fast rise time load transient are anticipated, and/or there is significant input resistance from the device to the input power supply.

POWER DISSIPATION AND JUNCTION TEMPERATURE

Specified regulator operation is assured to a junction temperature of 125°C; the maximum junction temperature allowable without damaging the device is 150°C. This restriction limits the power dissipation the regulator can handle in any given application. To ensure the junction temperature is within acceptable limits, calculate the maximum allowable dissipation, $P_{D(max)}$, and the actual dissipation, P_D , which must be less than or equal to $P_{D(max)}$.

The maximum-power-dissipation limit is determined using Equation 1:

$$P_{D(max)} = \frac{T_{J}max - T_{A}}{R_{\theta JA}}$$
(1)

Where:

- T_Jmax is the maximum allowable junction temperature.
- R_{θJA} is the thermal resistance junction-to-ambient for the package; see the package dissipation rating table.
- T_A is the ambient temperature.

The regulator dissipation is calculated using Equation 2:

$$P_{D} = (V_{I} - V_{O}) \times I_{O}$$
(2)

Power dissipation resulting from quiescent current is negligible.

PROGRAMMING THE TPS72101 ADJUSTABLE LDO REGULATOR

The output voltage of the TPS72101 adjustable regulator is programmed using an external resistor divider as shown in Figure 20. The output voltage is calculated using Equation 3:

$$V_{O} = V_{ref} \times \left(1 + \frac{R1}{R2}\right) \tag{3}$$

Where:

• V_{ref} = 1.225 V typ (the internal reference voltage)



APPLICATION INFORMATION (continued)

Resistors R1 and R2 should be chosen for approximately 10- μ A divider current. Lower value resistors can be used but offer no inherent advantage and waste more power. Higher values should be avoided, as leakage currents at FB increase the output voltage error. The recommended design procedure is to choose R2 = 30.1 k Ω to set the divider current at 10 μ A and then calculate R1 using Equation 4:

$$R1 = \left(\frac{V_{O}}{V_{ref}} - 1\right) \times R2 \tag{4}$$

Where:

• V_{ref} = 1.225 V.

$\begin{array}{c|c} \text{OUTPUT VOLTAGE} \\ \text{PROGRAMMING GUIDE} \\ \hline \text{OUTPUT} & \text{DIVIDER RESISTANCE} \\ \text{VOLTAGE} & (k\Omega)^1 \\ \text{(V)} & \text{R1} & \text{R2} \\ \hline 2.5 & 127 & 121 \\ \hline \end{array}$

Note (1): 1% values shown.

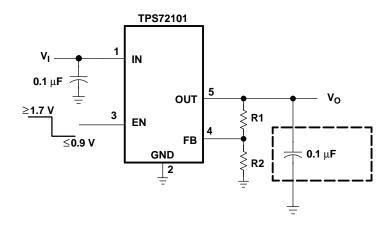


Figure 20. TPS72101 Adjustable LDO Regulator Programming

REGULATOR PROTECTION

The TPS721xx pass element has a built-in back diode that safely conducts reverse current when the input voltage drops below the output voltage (for example, during power down). Current is conducted from the output to the input and is not internally limited. If extended reverse voltage is anticipated, external limiting might be appropriate.

The TPS721xx also features internal current limiting and thermal protection. During normal operation, the TPS721xx limits output current to approximately 350 mA. When current limiting engages, the output voltage scales back linearly until the overcurrent condition ends. While current limiting is designed to prevent gross device failure, care should be taken not to exceed the power dissipation ratings of the package. If the temperature of the device exceeds 170°C, thermal-protection circuitry shuts it down. Once the device has cooled down to below 150°C, regulator operation resumes.

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PACKAGING INFORMATION

Orderable part number	Status (1)	Material type	Package Pins	Package qty Carrier	RoHS (3)	Lead finish/ Ball material	MSL rating/ Peak reflow	Op temp (°C)	Part marking (6)
TPS72101DBVR	Active	Production	SOT-23 (DBV) 5	3000 LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 125	PEKI
TPS72101DBVR.B	Active	Production	SOT-23 (DBV) 5	3000 LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 125	PEKI
TPS72101DBVT	Active	Production	SOT-23 (DBV) 5	250 SMALL T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 125	PEKI
TPS72101DBVT.B	Active	Production	SOT-23 (DBV) 5	250 SMALL T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 125	PEKI
TPS72101DBVTG4	Active	Production	SOT-23 (DBV) 5	250 SMALL T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 125	PEKI
TPS72101DBVTG4.B	Active	Production	SOT-23 (DBV) 5	250 SMALL T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 125	PEKI
TPS72115DBVR	Active	Production	SOT-23 (DBV) 5	3000 LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 125	PEII
TPS72115DBVR.B	Active	Production	SOT-23 (DBV) 5	3000 LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 125	PEII
TPS72115DBVRG4	Active	Production	SOT-23 (DBV) 5	3000 LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 125	PEII
TPS72115DBVT	Active	Production	SOT-23 (DBV) 5	250 SMALL T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 125	PEII
TPS72115DBVT.B	Active	Production	SOT-23 (DBV) 5	250 SMALL T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 125	PEII
TPS72115DBVTG4	Active	Production	SOT-23 (DBV) 5	250 SMALL T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 125	PEII
TPS72116DBVR	Active	Production	SOT-23 (DBV) 5	3000 LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 125	PHFI
TPS72116DBVR.B	Active	Production	SOT-23 (DBV) 5	3000 LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 125	PHFI
TPS72116DBVRG4	Active	Production	SOT-23 (DBV) 5	3000 LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 125	PHFI
TPS72116DBVRG4.B	Active	Production	SOT-23 (DBV) 5	3000 LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 125	PHFI
TPS72116DBVT	Active	Production	SOT-23 (DBV) 5	250 SMALL T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 125	PHFI
TPS72116DBVT.B	Active	Production	SOT-23 (DBV) 5	250 SMALL T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 125	PHFI
TPS72118DBVR	Active	Production	SOT-23 (DBV) 5	3000 LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 125	PEJI
TPS72118DBVR.B	Active	Production	SOT-23 (DBV) 5	3000 LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 125	PEJI
TPS72118DBVRG4	Active	Production	SOT-23 (DBV) 5	3000 LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 125	PEJI
TPS72118DBVRG4.B	Active	Production	SOT-23 (DBV) 5	3000 LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 125	PEJI
TPS72118DBVT	Active	Production	SOT-23 (DBV) 5	250 SMALL T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 125	PEJI
TPS72118DBVT.B	Active	Production	SOT-23 (DBV) 5	250 SMALL T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 125	PEJI
TPS72118DBVTG4	Active	Production	SOT-23 (DBV) 5	250 SMALL T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 125	PEJI

⁽¹⁾ Status: For more details on status, see our product life cycle.



PACKAGE OPTION ADDENDUM

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- (2) Material type: When designated, preproduction parts are prototypes/experimental devices, and are not yet approved or released for full production. Testing and final process, including without limitation quality assurance, reliability performance testing, and/or process qualification, may not yet be complete, and this item is subject to further changes or possible discontinuation. If available for ordering, purchases will be subject to an additional waiver at checkout, and are intended for early internal evaluation purposes only. These items are sold without warranties of any kind.
- (3) RoHS values: Yes, No, RoHS Exempt. See the TI RoHS Statement for additional information and value definition.
- (4) Lead finish/Ball material: Parts may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.
- (5) MSL rating/Peak reflow: The moisture sensitivity level ratings and peak solder (reflow) temperatures. In the event that a part has multiple moisture sensitivity ratings, only the lowest level per JEDEC standards is shown. Refer to the shipping label for the actual reflow temperature that will be used to mount the part to the printed circuit board.
- (6) Part marking: There may be an additional marking, which relates to the logo, the lot trace code information, or the environmental category of the part.

Multiple part markings will be inside parentheses. Only one part marking contained in parentheses and separated by a "~" will appear on a part. If a line is indented then it is a continuation of the previous line and the two combined represent the entire part marking for that device.

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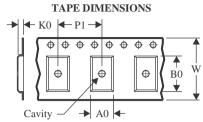
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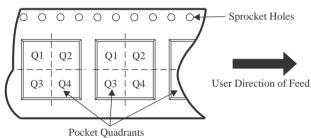
TAPE AND REEL INFORMATION





A0	Dimension designed to accommodate the component width
В0	Dimension designed to accommodate the component length
K0	Dimension designed to accommodate the component thickness
W	Overall width of the carrier tape
P1	Pitch between successive cavity centers

QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE

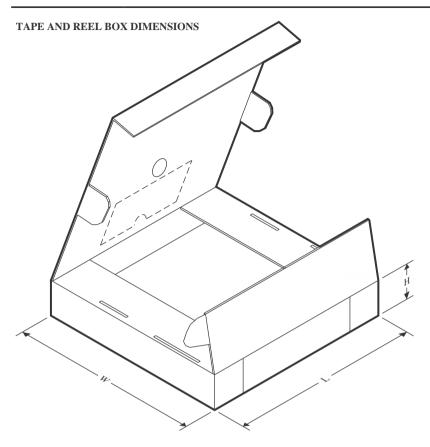


*All dimensions are nominal

Device	Package Type	Package Drawing		SPQ	Reel Diameter (mm)	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
TPS72101DBVR	SOT-23	DBV	5	3000	180.0	8.4	3.2	3.2	1.4	4.0	8.0	Q3
TPS72101DBVT	SOT-23	DBV	5	250	180.0	8.4	3.2	3.2	1.4	4.0	8.0	Q3
TPS72101DBVTG4	SOT-23	DBV	5	250	180.0	8.4	3.2	3.2	1.4	4.0	8.0	Q3
TPS72115DBVR	SOT-23	DBV	5	3000	178.0	9.0	3.23	3.17	1.37	4.0	8.0	Q3
TPS72115DBVT	SOT-23	DBV	5	250	178.0	9.0	3.23	3.17	1.37	4.0	8.0	Q3
TPS72116DBVR	SOT-23	DBV	5	3000	180.0	8.4	3.2	3.2	1.4	4.0	8.0	Q3
TPS72116DBVRG4	SOT-23	DBV	5	3000	180.0	8.4	3.2	3.2	1.4	4.0	8.0	Q3
TPS72116DBVT	SOT-23	DBV	5	250	179.0	8.4	3.2	3.2	1.4	4.0	8.0	Q3
TPS72118DBVR	SOT-23	DBV	5	3000	178.0	9.0	3.23	3.17	1.37	4.0	8.0	Q3
TPS72118DBVRG4	SOT-23	DBV	5	3000	178.0	9.0	3.23	3.17	1.37	4.0	8.0	Q3
TPS72118DBVT	SOT-23	DBV	5	250	178.0	9.0	3.23	3.17	1.37	4.0	8.0	Q3



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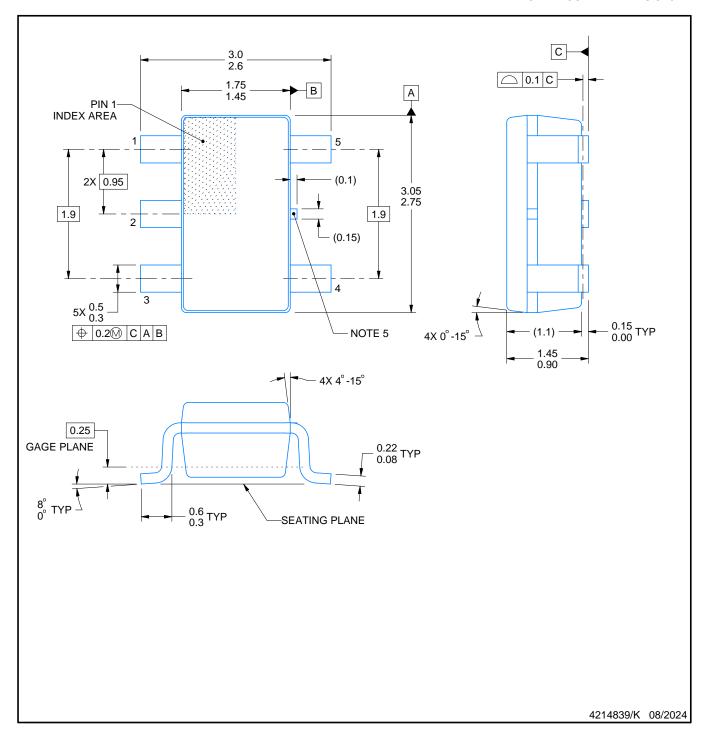


*All dimensions are nominal

7 til dimensions are nominal							
Device	Package Type	Package Drawing	Pins	SPQ	Length (mm)	Width (mm)	Height (mm)
TPS72101DBVR	SOT-23	DBV	5	3000	200.0	183.0	25.0
TPS72101DBVT	SOT-23	DBV	5	250	200.0	183.0	25.0
TPS72101DBVTG4	SOT-23	DBV	5	250	200.0	183.0	25.0
TPS72115DBVR	SOT-23	DBV	5	3000	180.0	180.0	18.0
TPS72115DBVT	SOT-23	DBV	5	250	180.0	180.0	18.0
TPS72116DBVR	SOT-23	DBV	5	3000	200.0	183.0	25.0
TPS72116DBVRG4	SOT-23	DBV	5	3000	200.0	183.0	25.0
TPS72116DBVT	SOT-23	DBV	5	250	200.0	183.0	25.0
TPS72118DBVR	SOT-23	DBV	5	3000	180.0	180.0	18.0
TPS72118DBVRG4	SOT-23	DBV	5	3000	180.0	180.0	18.0
TPS72118DBVT	SOT-23	DBV	5	250	180.0	180.0	18.0



SMALL OUTLINE TRANSISTOR



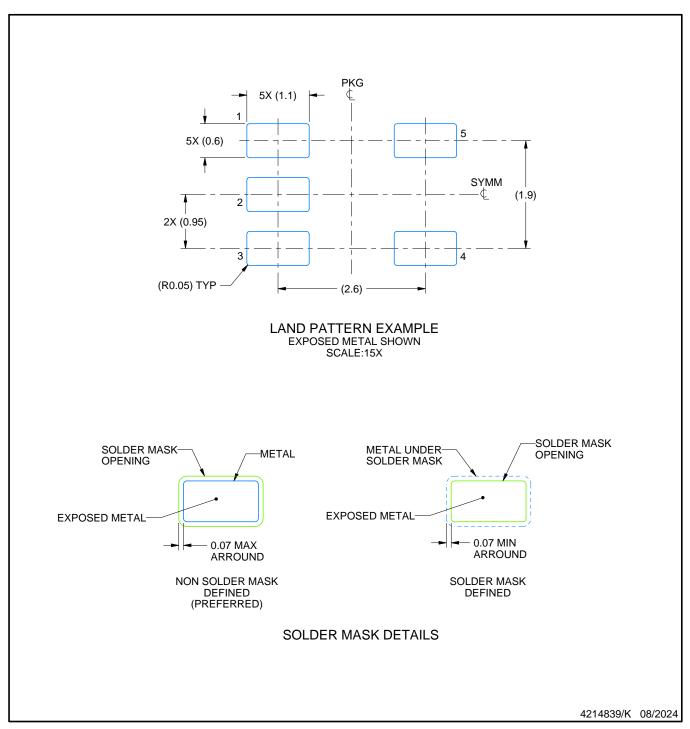
NOTES:

- 1. All linear dimensions are in millimeters. Any dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.
 2. This drawing is subject to change without notice.
 3. Reference JEDEC MO-178.

- 4. Body dimensions do not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed 0.25 mm per side.
- 5. Support pin may differ or may not be present.



SMALL OUTLINE TRANSISTOR



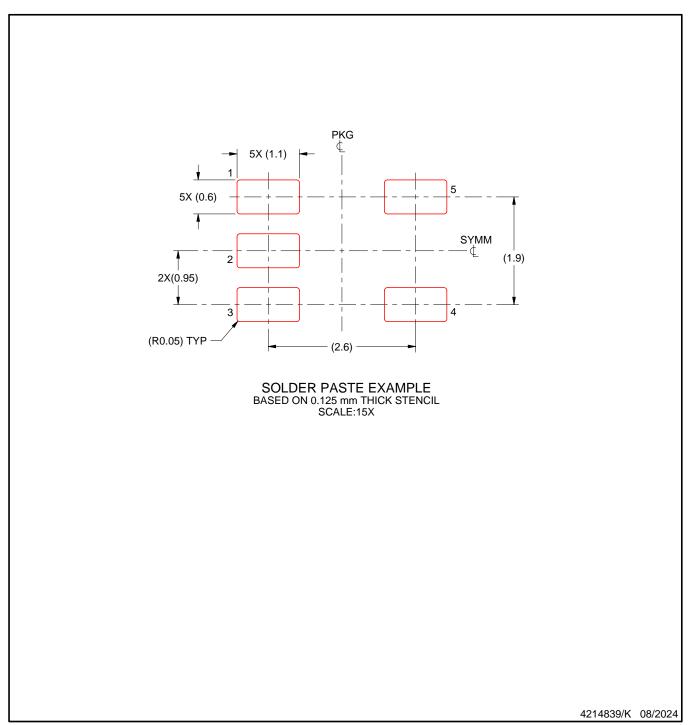
NOTES: (continued)

6. Publication IPC-7351 may have alternate designs.

7. Solder mask tolerances between and around signal pads can vary based on board fabrication site.



SMALL OUTLINE TRANSISTOR



NOTES: (continued)

- 8. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.
- 9. Board assembly site may have different recommendations for stencil design.



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